



30V SYNCHRONOUS N-CHANNEL ENHANCEMENT MODE MOSFET

PowerDI3333-8 (Type D)

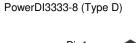
Product Summary

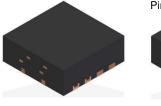
Device	BV _{DSS}	R _{DS(ON)} Max
Q1	30V	14.3m Ω @ V _{GS} = 8V, I _D = 4A
Q2	30V	14.3m (O V _{GS} = 8V, I _D = 4A

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- DC-DC Converters
- Power Management Functions
- Analog Switch





Top View

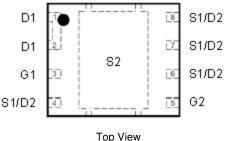
Bottom View

Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Note 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: PowerDI[®]3333-8 (Type D)
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.044 grams (Approximate)



Pin Configuration

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3013LFG-7	PowerDI3333-8 (Type D)	1000 / Tape & Reel
DMN3013LFG-13	PowerDI3333-8 (Type D)	3000 / Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

 See http://www.diodes.com/quality/lead_free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



N07 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 18 = 2018) WW = Week Code (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated. DMN3013LFG



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Q1	Q2	Unit	
Drain-Source Voltage	V _{DSS}	30		V	
Gate-Source Voltage	V _{GSS}	10		V	
	$T_{C} = +25^{\circ}C$ $T_{C} = +70^{\circ}C$	ID	15 12		A
Continuous Drain Current @ $V_{GS} = 5V$	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	9.5 7.6		А
Continuous Source-Drain Diode Current (Note 5)		ls	2.7	2.7	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	80	80	A
Avalanche Current (Note 6) L = 0.1mH		I _{AS}	24	24	A
Avalanche Energy (Note 6) L = 0.1mH		E _{AS}	28	28	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation	$T_A = +25^{\circ}C$	Р	2.16	W	
Total Power Dissipation	T _A = +70°C	PD	1.25	vv	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	58.8		
mermai Resistance, sunction to Ambient (Note 5)	t<10s	$R_{ heta JA}$	34	°C/W	
Thermal Resistance, Junction to Case		$R_{\theta JC}$	6.9		
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C		

Electrical Characteristics Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)			71	1	1	-
Drain-Source Breakdown Voltage	BV _{DSS}	30	-	-	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	IDSS	-	-	1	μA	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	-	-	100	nA	$V_{GS} = 10V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	0.75	0.95	1.2	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
		-	10.9	14.3	mΩ	$V_{GS} = 8V, I_D = 4A$
Static Drain-Source On-Resistance	R _{DS(ON)}	-	13.3	16.1	mΩ	$V_{GS} = 4.5V, I_D = 4A$
		-	15.3	17.7	mΩ	$V_{GS} = 3.5V, I_D = 4A$
Forward Transfer Admittance	Y _{fs}	-	13	-	S	V _{DS} = 15V, I _D =4A
Diode Forward Voltage	V _{SD}	-	0.8	1.0	V	$V_{GS} = 0V, I_{S} = 4A$
DYNAMIC CHARACTERISTICS (Note 8)						÷
Input Capacitance	Ciss	-	387	600	pF	V_{DS} = 15V, V_{GS} = 0V, f = 1.0MHz
Output Capacitance	C _{oss}	-	219	350		
Reverse Transfer Capacitance	Crss	-	10.4	16		
Gate Resistance	Rg	-	3.3	6.8	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1.0MHz
Total Gate Charge (V _{GS} = 4.5V)	Qa	-	3.3	5.7		V _{DS} = 15V, I _D = 4A
Total Gate Charge at V _{TH}	Q _{q(TH)}	-	0.37	-		
Gate-Source Charge	Q _{qs}	-	0.6	-	nC	
Gate-Drain Charge	Q _{ad}	-	0.6	-		
Turn-On Delay Time	t _{D(ON)}	-	4.2	6.3		$V_{DD} = 15V, V_{GS} = 4.5V, \label{eq:VDD}$ $I_D = 4A, R_g = 2\Omega, \label{eq:VDD}$
Turn-On Rise Time	t _R	-	6.2	-		
Turn-Off Delay Time	t _{D(OFF)}	-	9.7	15	ns	
Turn-Off Fall Time	t _F	-	2.0	-	1	
Reverse Recovery Time	t _{RR}	-	11.7	-	ns	V _{DS} = 15V,I _F = 4A, di/dt =
Reverse Recovery Charge	Q _{RB}	-	7.5	-	nC	300A/µs

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

6. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}$ C. 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.

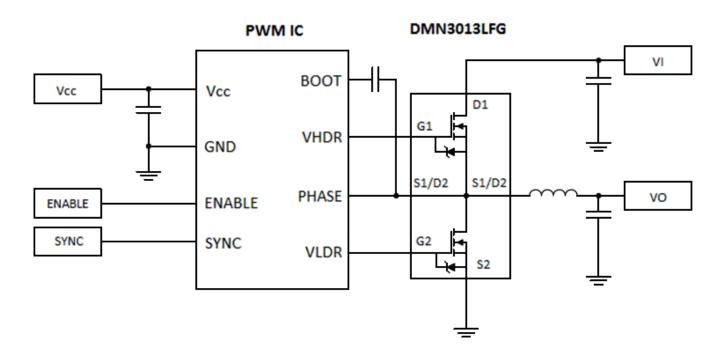


Electrical Characteristics Q2 (@T_A = +25°C, unless otherwise specified.)

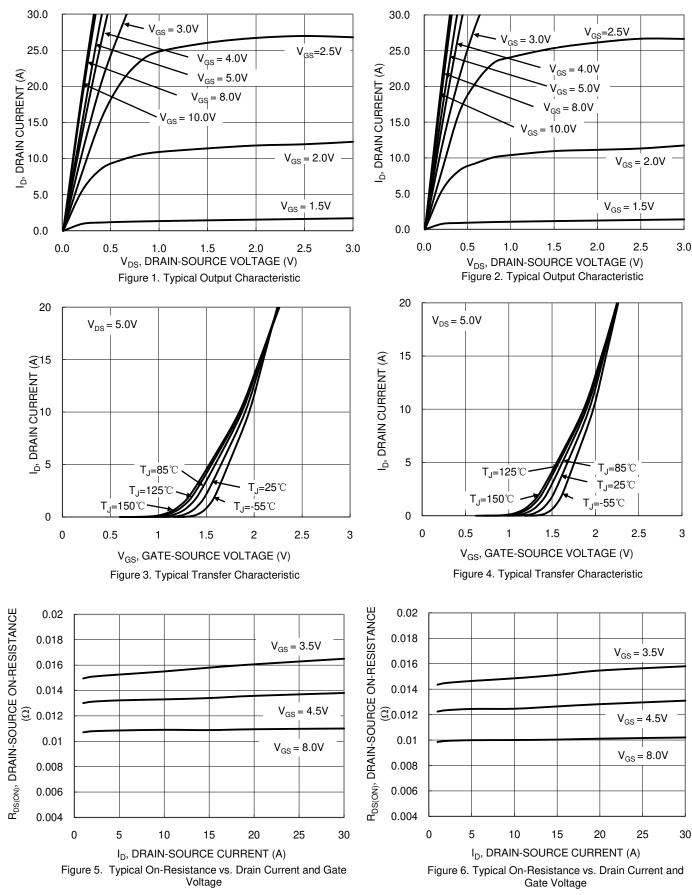
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)					•		
Drain-Source Breakdown Voltage	BV _{DSS}	30	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current TJ = +25°C	IDSS	-	-	1.0	μA	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	-	-	100	nA	$V_{GS} = 10V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	0.75	0.95	1.2	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
		-	10.2	14.3	mΩ	$V_{GS} = 8V, I_D = 4A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	-	12.7	16.1	mΩ	$V_{GS} = 4.5V, I_D = 4A$	
		-	14.8	17.7	mΩ	$V_{GS} = 3.5V, I_D = 4A$	
Forward Transfer Admittance	Y _{fs}	-	13	-	S	V _{DS} =15V, I _D =4A	
Diode Forward Voltage	V _{SD}	-	0.8	1.0	V	$V_{GS} = 0V, I_S = 4A$	
DYNAMIC CHARACTERISTICS (Note 8)						·	
Input Capacitance	Ciss	-	397	600	pF	$V_{DS} = 15V, V_{GS} = 0V,$ f = 1.0MHz	
Output Capacitance	C _{oss}	-	217	350	pF		
Reverse Transfer Capacitance	Crss	-	10.4	16	pF		
Gate Resistance	Rg	-	3.3	6.8	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg		3.4	5.7	nC		
Total Gate Charge at VTH	Q _{g(TH)}	-	0.39	-	nC		
Gate-Source Charge	Q _{gs}	-	0.6	-	nC	$-V_{DS} = 15V, I_{D} = 4A$	
Gate-Drain Charge	Q _{qd}	-	0.6	-	nC		
Turn-On Delay Time	t _{D(ON)}	-	4.4	6.3	ns		
Turn-On Rise Time	t _B	-	6.7	-	ns	$V_{DD} = 15V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	t _{D(OFF)}	-	10.4	15	ns	$I_D = 4A, R_g = 2\Omega$	
Turn-Off Fall Time	t _F	-	2.2	-	ns		
Reverse Recovery Time	t _{BB}	-	11.8	-	ns	Vps = 15V. IF = 4A. di/dt =	
Reverse Recovery Charge	Q _{RR}	-	7.8	-	nC	300A/µs	

Notes: 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.

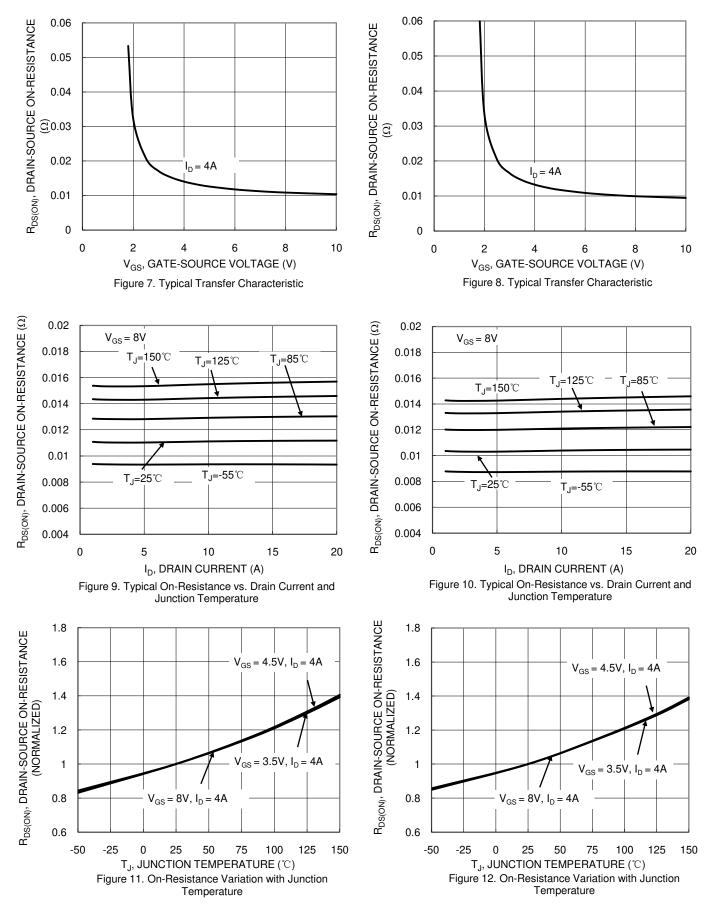
Typical Circuit





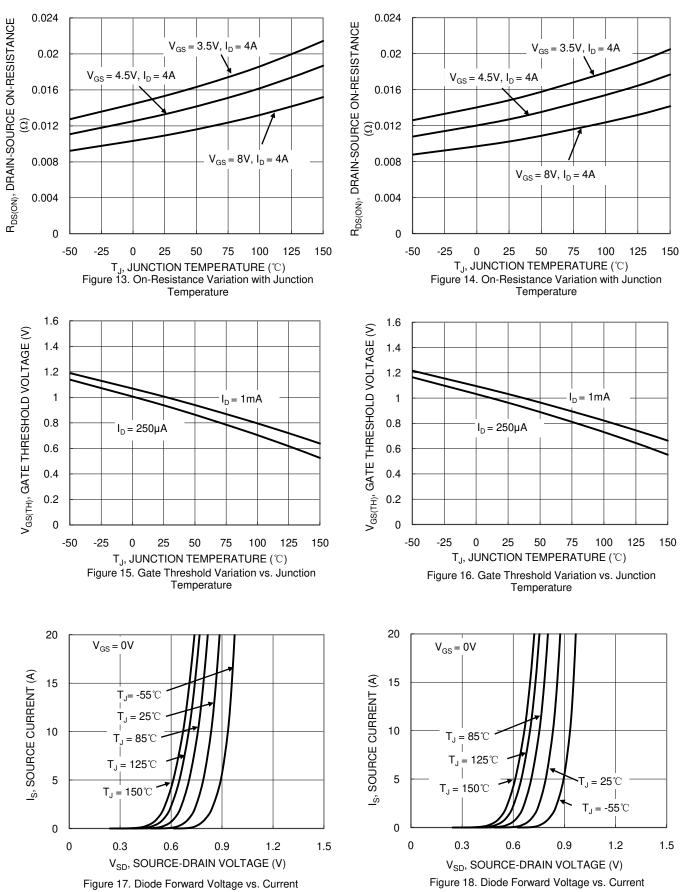




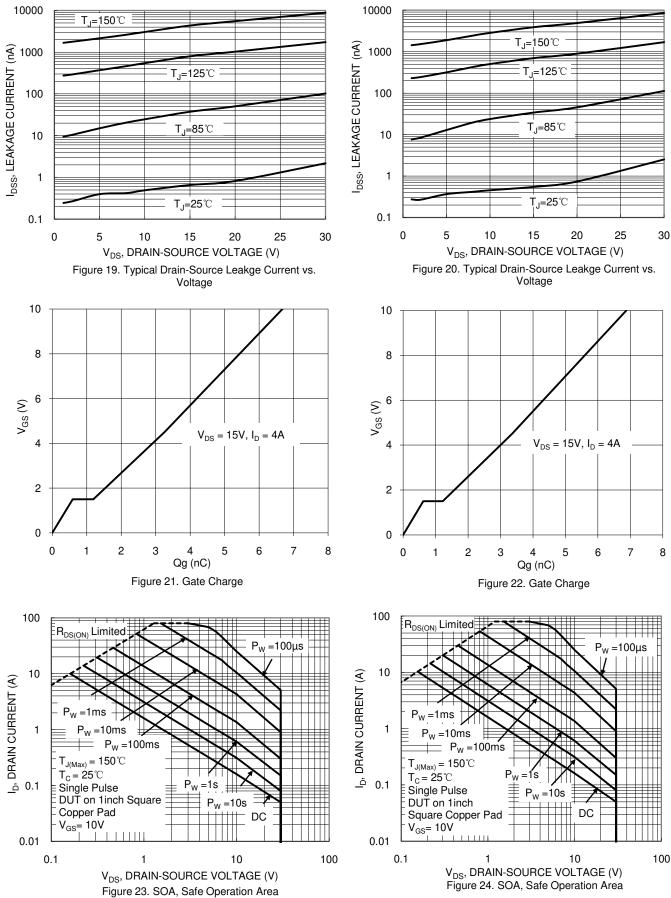


DMN3013LFG Document number: DS40407 Rev. 2 - 2

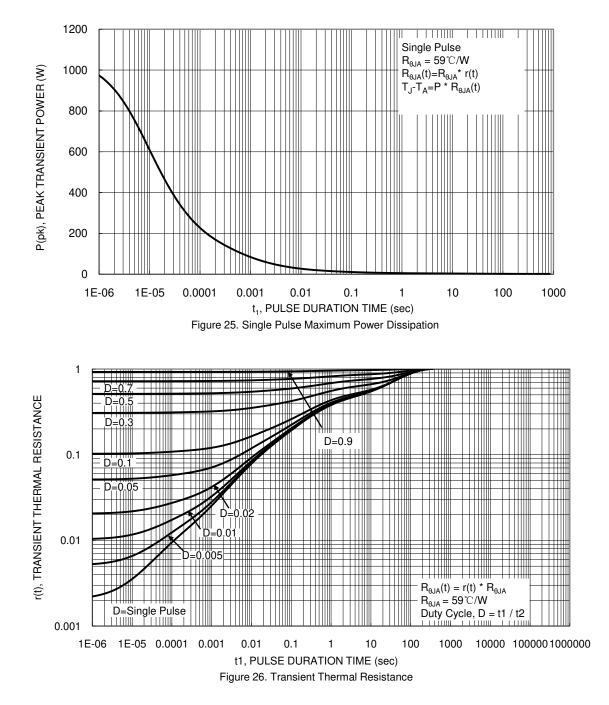










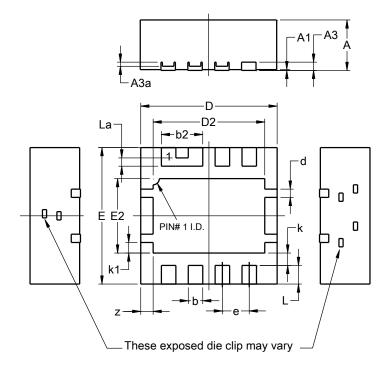




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

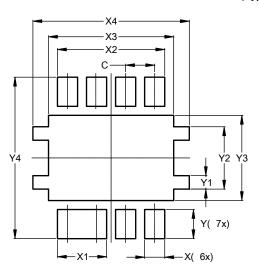
PowerDI3333-8 (Type D)



PowerDI3333-8 (Type D)						
Dim	Min	Max	Тур			
Α	1.17	1.23	1.20			
A1	0.00	0.05	0.02			
A3	0.15	0.25	0.20			
A3a	0.05	0.15	0.10			
b	0.30	0.40	0.35			
b2	0.95	1.05	1.00			
D	3.20	3.40	3.30			
D2	2.65	2.75	2.70			
Е	3.20	3.40	3.30			
E2	1.75	1.85	1.80			
d	0.15	0.25	0.20			
е			0.65			
k			0.30			
k1	0.21	0.31	0.26			
L	0.40	0.50	0.45			
La	0.15	0.25	0.20			
Z	0.25	0.35	0.30			
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)			
С	0.650			
Х	0.450			
X1	1.100			
X2	2.400			
X3	2.800			
X4	3.500			
Y	0.650			
Y1	0.300			
Y2	1.390			
Y3	1.900			
¥4	3.600			

PowerDI3333-8 (Type D)



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2018, Diodes Incorporated

www.diodes.com